

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











60V N-CHANNEL SELF PROTECTED ENHANCEMENT MODE *INTELLIFET®* MOSFET

Product Summary

Continuos Drain Source Voltage 60V $200 m\Omega$ On-State Resistance Nominal Load Current (V_{IN} = 5V) 1.8A Clamping Energy 210mJ

Description

The ZXMS6005DT8 is a dual self protected low side MOSFET with logic level input. It integrates over-temperature, over-current, over-voltage (active clamp) and ESD protected logic level functionality. The ZXMS6005DT8 is ideal as a general purpose switch driven from 3.3V or 5V microcontrollers in harsh environments where standard MOSFETs are not rugged enough.

Applications

- Lamp Driver
- Motor Driver
- Relay Driver
- Solenoid Driver

Features and Benefits

- Compact Dual Package
- Low Input Current
- Logic Level Input (3.3V and 5V)
- Short Circuit Protection with Auto Restart
- Over Voltage Protection (active clamp)
- Thermal Shutdown with Auto Restart
- Over-Current Protection
- Input Protection (ESD)
- High Continuous Current Rating
- Lead-Free Finish; RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- AEC-Q101-006 Short Circuit Reliability Characterized
- PPAP Capable (Note 4)

Mechanical Data

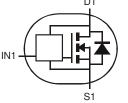
Case: SM-8

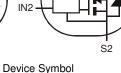
D2

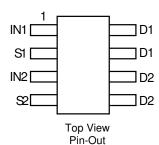
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish @3
- Weight: 0.117 grams (approximate)











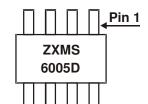
Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXMS6005DT8TA	ZXMS6005D	7	12	1,000

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

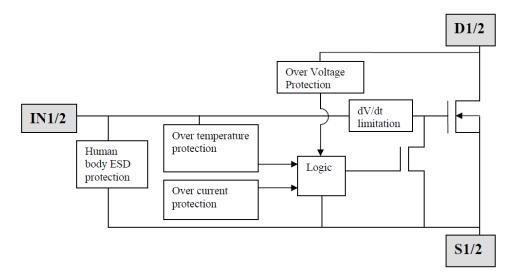


ZXMS6005D = Product Type Marking Code

Top View



Functional Block Diagram



Application Information

- Two completely isolated independent channels
- Especially suited for loads with a high in-rush current such as lamps and motors
- · All types of resistive, inductive and capacitive loads in switching applications
- μC compatible power switch for 12V DC applications
- Automotive rated
- · Replaces electromechanical relays and discrete circuits
- Linear Mode Capability the current-limiting protection circuitry is designed to de-activate at low V_{DS} to minimise on state power dissipation. The maximum DC operating current is therefore determined by the thermal capability of the package/board combination, rather than by the protection circuitry. This does not compromise the product's ability to self-protect at low V_{DS}

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Continuous Drain-Source Voltage	V _{DS}	60	V
Drain-Source Voltage For Short Circuit Protection	V _{DS(SC)}	24	V
Continuous Input Voltage	V _{IN}	-0.5 to +6	V
Continuous Input Current @ $-0.2V \le V_{IN} \le 6V$ Continuous Input Current @ $V_{IN} < -0.2V$ or $V_{IN} > 6V$	I _{IN}	No limit I _{IN} ≤2	mA
Pulsed Drain Current @V _{IN} = 3.3V (Note 7)	I _{DM}	5	Α
Pulsed Drain Current @V _{IN} = 5V (Note 7)	I _{DM}	6	Α
Continuous Source Current (Body Diode) (Note 5)	Is	2.5	Α
Pulsed Source Current (Body Diode)	I _{SM} 10		Α
Unclamped Single Pulse Inductive Energy, T _J = +25°C, I _D = 0.5A, V _{DD} = 24V	Eas	210	mJ
Electrostatic Discharge (Human Body Model)	V _{ESD}	4000	V
Charged Device Model	V _{CDM}	1000	V



Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Power Dissipation at $T_A = +25^{\circ}C$ (Notes 5 & 8) Linear Derating Factor	P _D	1.16 9.28	W mW/°C
Power Dissipation at T _A = +25°C (Notes 5 & 9) Linear Derating Factor	P _D	1.67 13.3	W mW/°C
Power Dissipation at T _A = +25°C (Notes 6 & 8) Linear Derating Factor	P _D	2.13 17	W mW/°C
Thermal Resistance, Junction to Ambient (Notes 5 & 8)	$R_{\theta JA}$	108	°C/W
Thermal Resistance, Junction to Ambient (Notes 5 & 9)	R _{0JA}	75	°C/W
Thermal Resistance, Junction to Case (Notes 6 & 8)	Rejc	58.7	°C/W
Thermal Resistance, Junction to Case (Note 10)	Rejc	26.5	°C/W
Operating Temperature Range	TJ	-40 to +150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Notes:

- 5. For a dual device surface mounted on a 25mm x 25mm single sided 1oz weight copper split down the middle on 1.6mm FR4 board, in still air
- 6. For a dual device surface mounted on FR4 PCB measured at t ≤ 10sec.
- For a dual device strated intollined on FR4 PCB measured at 15 Tosec.
 Repetitive rating25mm x 25mm FR4 PCB, D = 0.02, Pulse width = 300µs pulse width limited by junction temperature. Refer to transient thermal impedance graph.
 For a dual device with one active die.
 For a dual device with 2 active die running at equal power.
 Thermal large transient to the parameters of the dual resistance from installed in the parameters of the dual resistance.

- 10. Thermal resistance from junction to the mounting surface of the drain pin.

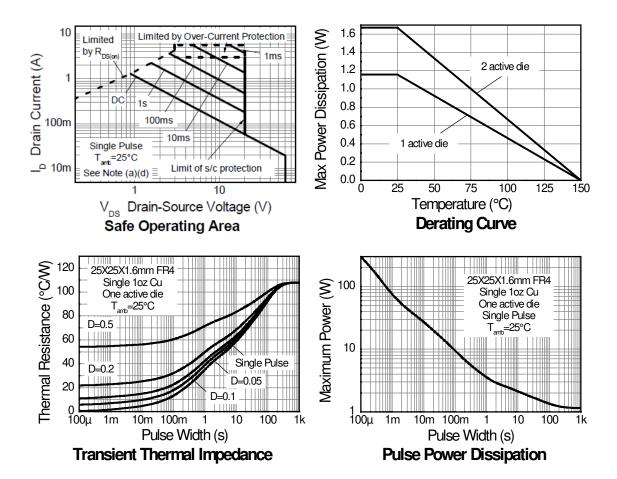
Recommended Operating Conditions

The ZXMS6005DT8 is optimized for use with μC operating from 3.3V and 5V supplies.

Characteristic	Symbol	Min	Max	Unit
Input Voltage Range	V _{IN}	0	5.5	V
Ambient Temperature Range	TA	-40	+125	°C
High Level Input Voltage for MOSFET to be on	V _{IH}	3	5.5	V
Low Level Input Voltage for MOSFET to be off	V _{IL}	0	0.7	V
Peripheral Supply Voltage (voltage to which load is referred)	V _P	0	24	V



Thermal Characteristics





Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

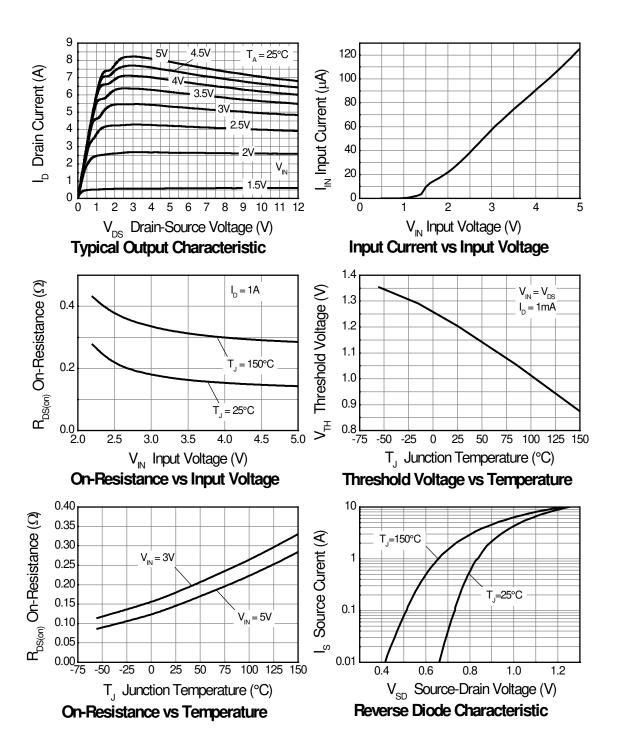
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Static Characteristics					•	
Drain-Source Clamp Voltage	V _{DS(AZ)}	60	65	70	V	$I_D = 10mA$
Off State Drain Current		_	_	1	μΑ	V _{DS} = 12V, V _{IN} = 0V
On State Drain Current	I _{DSS}	_	_	2		$V_{DS} = 36V$, $V_{IN} = 0V$
Input Threshold Voltage	V _{IN(th)}	0.7	1	1.5	V	$V_{DS} = V_{GS}$, $I_D = 1mA$
Input Current	1	_	60	100	μΑ	$V_{IN} = +3V$
Imput Guirent	I _{IN}	_	120	200		$V_{IN} = +5V$
Input Current while Over Temperature Active	_	_	_	300	μΑ	$V_{IN} = +5V$
Static Drain-Source On-State Resistance	0	_	170	250	mΩ	$V_{IN} = +3V, I_D = 1A$
Static Dialii-Source Oil-State Resistance	R _{DS(on)}	1	150	200		$V_{IN} = +5V$, $I_D = 1A$
Continuous Drain Current (Notes 5 & 9)		1.4	_	_	А	$V_{IN} = 3V; T_A = +25^{\circ}C$
Continuous Drain Current (Notes 5 & 9)		1.6	_	_		$V_{IN} = 5V$; $T_A = +25^{\circ}C$
Continuous Drain Current (Notes 5 & 8)	I _D	1.7	_	_		$V_{IN} = 3V; T_A = +25^{\circ}C$
Continuous Diam Current (Notes 5 & 6)		1.8	_	_		$V_{IN} = 5V; T_A = +25^{\circ}C$
Current Limit (Note 11)	I _{D(LIM)}	2.2	5	_	Α	$V_{IN} = +3V$
Current Limit (Note 11)		3.3	7	_		$V_{IN} = +5V$
Dynamic Characteristics						
Turn On Delay Time	t _{d(on)}		6	_	μs	
Rise Time	t _r	_	14	_	μs	V 10V I 10 V 5V
Turn Off Delay Time	t _{d(off)}	_	34	_	μs	$V_{DD} = 12V, I_D = 1A, V_{GS} = 5V$
Fall Time	f _f		19	_	μs	
Over-Temperature Protection						
Thermal Overload Trip Temperature (Note 12)	T_{JT}	150	175	_	°C	
Thermal Hysteresis (Note 12)	f _f	1	10	_	°C	_

Notes:

The drain current is restricted only when the device is in saturation (see graph 'typical output characteristic'). This allows the device to be used in the fully on state without interference from the current limit. The device is fully protected at all drain currents, as the low power dissipation generated outside saturation makes current limit unnecessary.
 Over-temperature protection is designed to prevent device destruction under fault conditions. Fault conditions are considered as "outside" normal operating range, so this part is not designed to withstand over-temperature for extended periods.

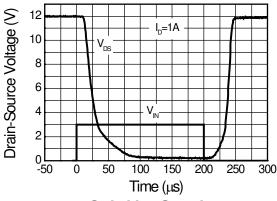


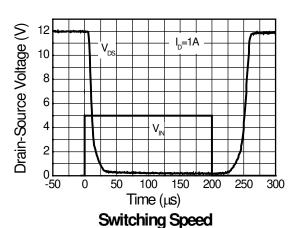
Typical Characteristics



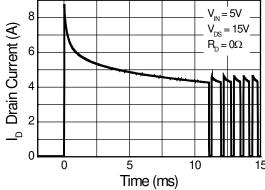


Typical Characteristics (cont.)





Switching Speed

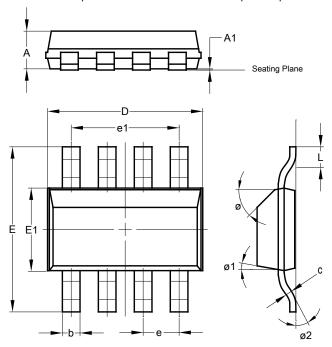


Typical Short Circuit Protection



Package Outline Dimensions

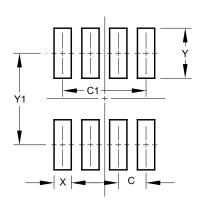
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SM-8				
Dim	Min Max Typ			
Α		1.70	1.60	
A1	0.02	0.10	0.04	
b	0.70	0.90	0.80	
С	0.24	0.32	0.28	
D	6.30	6.70	6.60	
е	1.53 REF			
e1	4.59 REF			
E	6.70	7.30	7.00	
E1	3.30	3.70	3.50	
L	L 0.75 1.00 0.90			
Ø	45°			
Ø1		15°		
Ø2			10°	
All Dimensions in mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	1.52		
C1	4.60		
Х	0.95		
Υ	2.80		
V1	6.80		



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2014, Diodes Incorporated

www.diodes.com